

# N-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

### DESCRIPTION

The  $\mu$ PA1870 is a switching device which can be driven directly by a 2.5-V power source.

The  $\mu$ PA1870 features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

### **FEATURES**

- Can be driven by a 2.5-V power source
- · Low on-state resistance  $R_{DS(on)1} = 20.0 \text{ m}\Omega \text{ MAX.}$  (Vgs = 4.5 V, ID = 3.0 A)  $R_{DS(on)2} = 21.0 \text{ m}\Omega \text{ MAX.}$  (Vgs = 4.0 V, ID = 3.0 A)  $R_{DS(on)3} = 27.0 \text{ m}\Omega \text{ MAX.}$  (Vgs = 2.5 V, ID = 3.0 A)
- Built-in G-S protection diode against ESD

#### **ORDERING INFORMATION**

PART NUMBER	PACKAGE
$\mu$ PA1870GR-9JG	Power TSSOP8

#### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^{\circ}C$ )

Drain to Source Voltage	VDSS	20
Gate to Source Voltage	Vgss ±12	
Drain Current (DC)	D(DC)	±6.0
Drain Current (pulse) <sup>Note 1</sup>	D(pulse)	±80
Total Power Dissipation Note 2	Ρτ	2.0
Channel Temperature	Tch	150
Storage Temperature	Tstg	–55 to +150

#### **Notes 1.** PW $\leq$ 10 $\mu$ s, Duty Cycle $\leq$ 1%

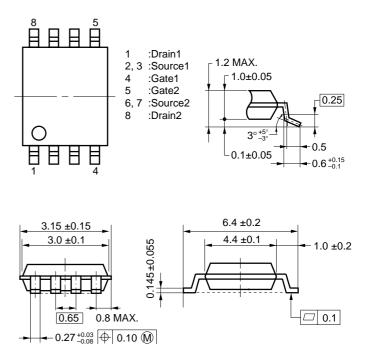
- 2. Mounted on ceramic substrate of 50 cm<sup>2</sup> x 1.1 mm
- Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

V

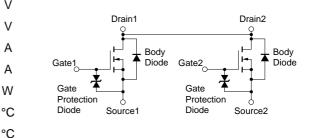
V

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# PACKAGE DRAWING (Unit: mm)



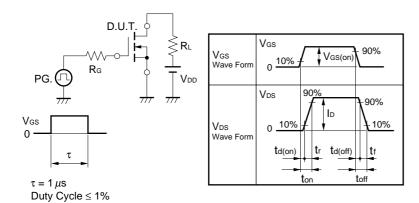
#### **EQUIVALENT CIRCUIT**



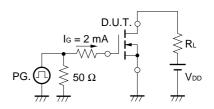
# ELECTRICAL CHARACTERISTICS (TA = 25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	loss	$V_{DS} = 20 V, V_{GS} = 0 V$			10	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 12 V$ , $V_{DS} = 0 V$			±10	μA
Gate Cut-off Voltage	VGS(off)	Vds = 10 V, Id = 1 mA	0.5	1.0	1.5	V
Forward Transfer Admittance	<b>y</b> fs	Vds = 10 V, Id = 3.0 A	5			S
Drain to Source On-state Resistance	RDS(on)1	$V_{GS} = 4.5 V$ , $I_{D} = 3.0 A$	12.0	15.0	20.0	mΩ
	RDS(on)2	$V_{GS} = 4.0 \text{ V}, \text{ ID} = 3.0 \text{ A}$	13.0	15.5	21.0	mΩ
	RDS(on)3	Vgs = 2.5 V, Id = 3.0 A	15.0	20.8	27.0	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = 10 V		900		pF
Output Capacitance	Coss	Vgs = 0 V		295		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		170		pF
Turn-on Delay Time	td(on)	Vdd = 10 V, Id = 3.0 A		55		ns
Rise Time	tr	$V_{GS(on)} = 4.0 V$		210		ns
Turn-off Delay Time	td(off)	$R_G = 10 \Omega$		300		ns
Fall Time	tr			340		ns
Total Gate Charge	QG	Vdd = 16 V		10		nC
Gate to Source Charge	QGS	Vgs = 4.0 V		2		nC
Gate to Drain Charge	Qgd	ID = 6.0 A		6		nC
Body Diode Forward Voltage	VF(S-D)	IF = 6.0 A, VGS = 0 V		0.80		V
Reverse Recovery Time	trr	IF = 6.0 A, VGS = 0 V		400		ns
Reverse Recovery Charge	Qrr	di/dt = 50 A / $\mu$ s		1000		nC

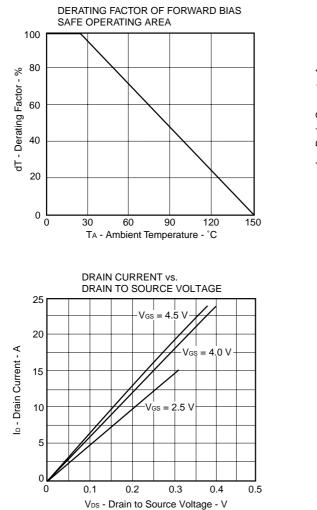
#### **TEST CIRCUIT 1 SWITCHING TIME**

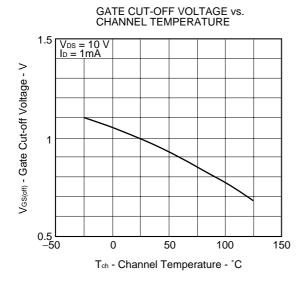


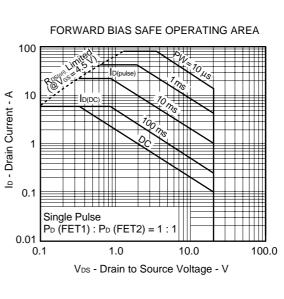
# TEST CIRCUIT 2 GATE CHARGE



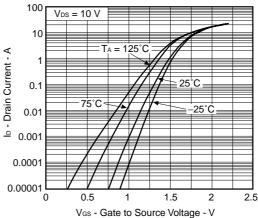
# TYPICAL CHARACTERISTICS (TA = 25°C)



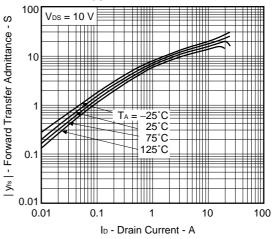


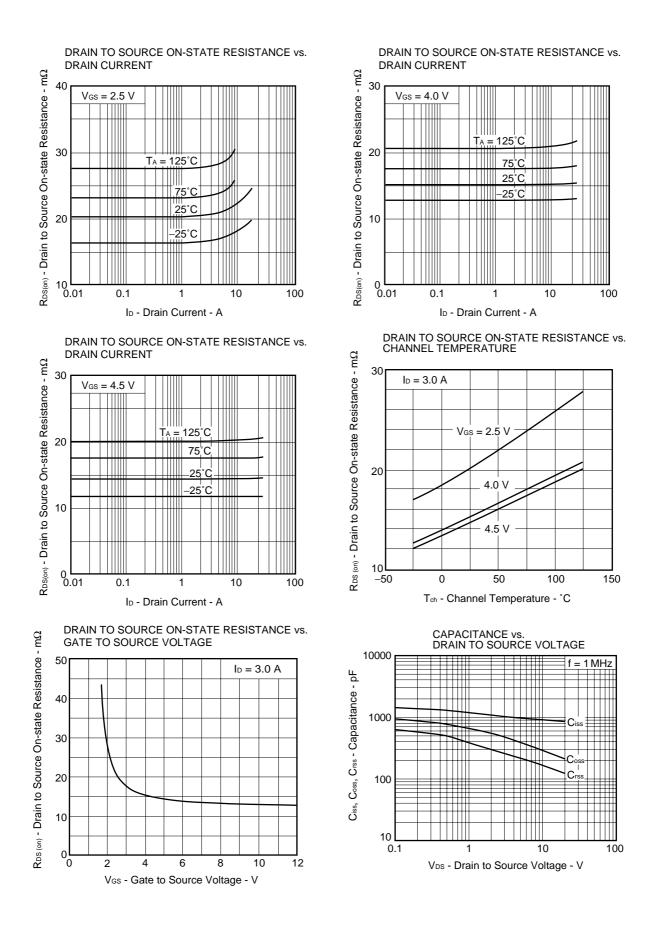


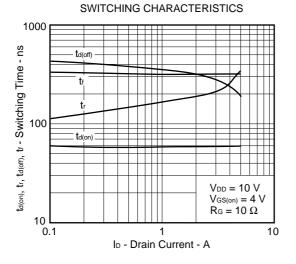
FORWARD TRANSFER CHARACTERISTICS



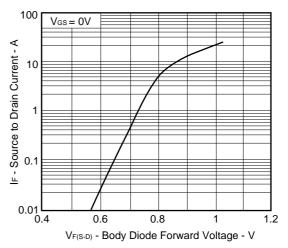




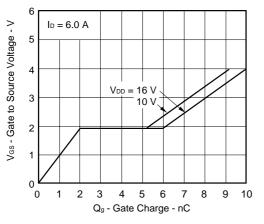


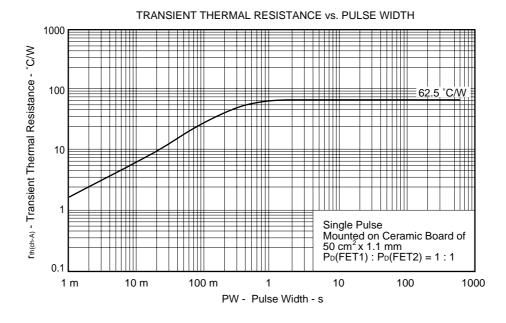


SOURCE TO DRAIN DIODE FORWARD VOLTAGE



DYNAMIC INPUT CHARACTERISTICS





Data Sheet G14886EJ1V0DS

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